

Features

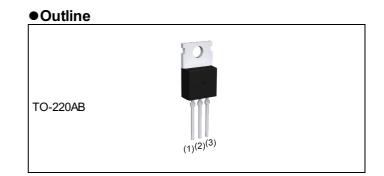
1) Low on - resistance

2) High power package (TO220AB)

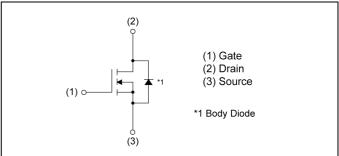
RX3N07BBH

Nch 80V 100A Power MOSFET

V _{DSS}	80V
R _{DS(on)} (Max.)	5.1mΩ
Ι _D	±100A
P _D	89W



Inner circuit



• Application • Packaging specifications • Application Packing Tube Switching Packing Tube Motor drives DC/DC converter DC/DC converter RX3N07BBH

• Absolute maximum ratings (T_a = 25°C ,unless otherwise specified)

Para	meter	Symbol	Value	Unit
Drain - Source voltage		V _{DSS}	80	V
O attinue desire annual	Silicon limit (V _{GS} =10V)	۱ _D *1	±100	А
Continuous drain current	T _c = 25°C (V _{GS} =10V)	I _D *2	±70	А
Pulsed drain current		ا _{DP} *3	±400	А
Gate - Source voltage		V _{GSS}	±20	V
Avalanche current, single pulse		I _{AS} *4	23	А
Avalanche energy, single pulse		E_{AS}^{*4}	42	mJ
Power dissipation		P _D *2	89	W
Junction temperature		Tj	150	S
Operating junction and storage temperature range		T _{stg}	-55 to +150	°C

3) Pb-free plating ; RoHS compliant4) Halogen free5) 100% Rg and UIS tested

•Thermal resistance

Parameter	Symbol	Values			Linit
Falameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R_{thJC}^{*2}	-	-	1.4	°C/W

•Electrical characteristics (T_a = 25°C)

Deremeter	Currente e l	Conditions		Values		Unit	
Parameter	Symbol Conditions –		Min.	Тур.	Max.	Unit	
Drain - Source breakdown voltage	$V_{(BR)DSS}$ $V_{GS} = 0V, I_D = 1mA$		80	-	-	V	
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{i}} I_{D} = 1mA$ referenced to 25°C		-	58	-	mV/°C	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 80V, V _{GS} = 0V	-	-	5	μA	
Gate - Source leakage current	I_{GSS} $V_{GS} = \pm 20V, V_{DS} = 0V$		-	-	±500	nA	
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 1mA$	2.0	-	4.0	V	
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{GS(th)}}{\Delta T_i} I_D = 1 \text{mA}$ referenced to 25°C		-	-5.0	-	mV/°C	
Static drain - source	D *5	V _{GS} = 10V, I _D = 70A	-	4.2	5.1		
on - state resistance	$R_{DS(on)}^{*5}$	V _{GS} = 6V, I _D = 35A	-	5.1	7.1	mΩ	
Gate resistance	R _G	-	-	1.0	-	Ω	
Forward Transfer Admittance	Y _{fs} * ⁵			-	-	S	

*1 Limited by silicon chip capability.

*2 T_c=25°C, Limited only by maximum temperature allowed.

*3 Pw \leq 10µs, Duty cycle \leq 1%

*4 L \simeq 0.1mH, V_{DD} = 40V, R_G = 25 Ω , Starting T_j = 25°C Fig.3-1,3-2

*5 Pulsed



•Electrical characteristics (T_a = 25°C)

Deremeter	Cumph of	Conditions	Values			Unit	
Parameter	Symbol Conditions -		Min.	Тур.	Max.	Unit	
Input capacitance	C _{iss}	V _{GS} = 0V	-	3280	-		
Output capacitance	C _{oss}	V _{DS} = 40V	-	730	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	23	-		
Turn - on delay time	t _{d(on)} *5	$V_{DD} \simeq 40V, V_{GS}$ = 10V	-	32	-		
Rise time	t _r *5	I _D = 35A	-	16	-	-	
Turn - off delay time	t _{d(off)} *5	$R_L \simeq 1.14\Omega$	-	63	-	ns	
Fall time	t _f *5	R _G = 10Ω	-	38	-		

• Gate charge characteristics ($T_a = 25^{\circ}C$)

Deremeter	Sumbol	Symbol Conditions		Values			Lincit
Parameter	Symbol			Min.	Тур.	Max.	Unit
Tatal asta al anna 0.*5	O *5	Q_g^{*5} $V_{DD} \simeq 40V$	V _{GS} = 10V	-	46.0	-	
Total gate charge	Qg°			-	28.0	-	nC
Gate - Source charge	Q_{gs}^{*5}	I _D = 50A	V _{GS} = 6V	-	10.4	-	nc
Gate - Drain charge	Q _{gd} *5			-	7.1	-	

•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Deremeter	Sumbol	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Continuous forward current	۱ _S *2	T _a = 25℃	-	-	70	А
Pulse forward current	I_{SP}^{*3}	$T_a = 25 C$	-	-	400	А
Forward voltage	V_{SD}^{*5}	V _{GS} = 0V, I _S = 70A	-	-	1.5	V
Reverse recovery time	t _{rr} *5	I _S = 50A, V _{GS} =0V	-	53	-	ns
Reverse recovery charge	Q _{rr} *5	di/dt = 100A/µs	-	54	-	nC





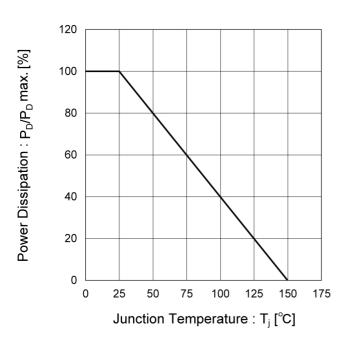


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area

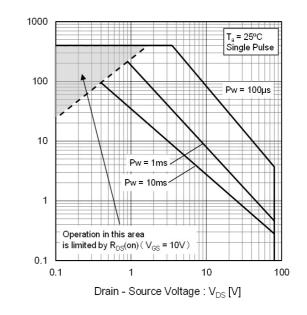
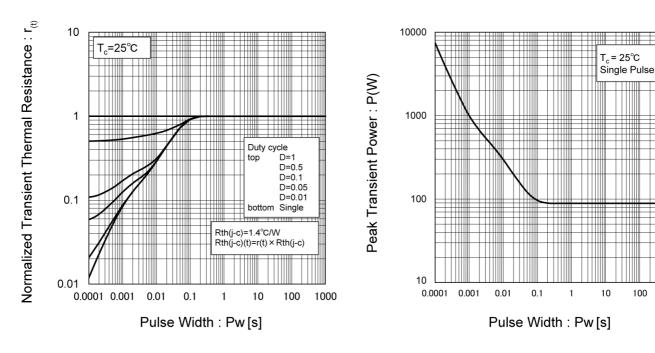


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

Fig.4 Single Pulse Maximum Power Dissipation



Drain Current : I_D [A]



100

1000

• Electrical characteristic curves

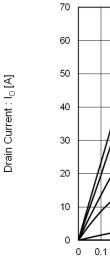


Fig.5 Typical Output Characteristics(I)

T_a = 25℃ Pulsed

Drain Current : I_D [A]

V_{GS} = 10V

 $V_{GS} = 6.0V$ $V_{GS} = 4.5V$

V_{GS}= 4.0V

V_{GS}= 3.5V

V₆₅= 3.0V

1

0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9

Drain - Source Voltage : V_{DS} [V]

Fig.6 Typical Output Characteristics(II)

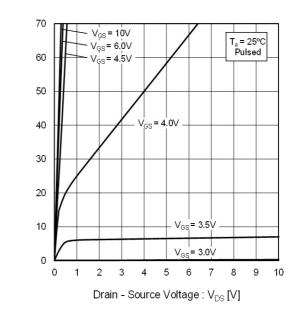


Fig.7 Normalized Breakdown Voltage vs. Junction Temperature

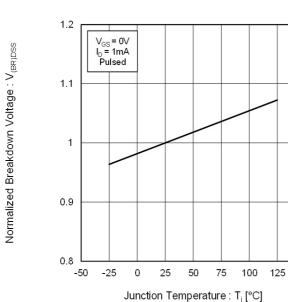
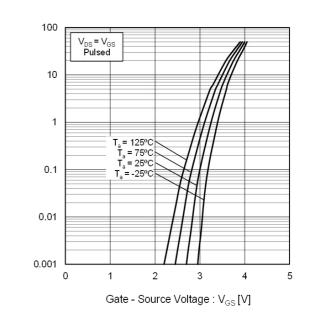


Fig.8 Typical Transfer Characteristics



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Drain Current : I_D [A]



• Electrical characteristic curves

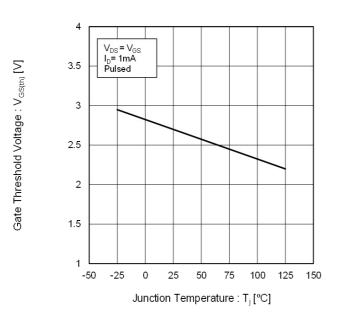
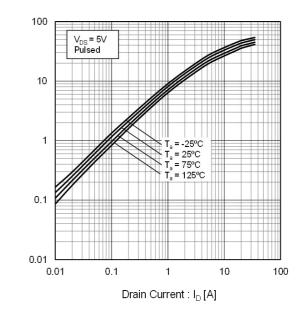


Fig.9 Gate Threshold Voltage vs. Junction Temperature



Forward Transfer Admittance : Y_{fs} [S]

Fig.10 Forward Transfer Admittance vs. Drain Current

Fig.11 Drain Current Derating Curve

Drain Current Dissipation : I_D/I_D max. [%]

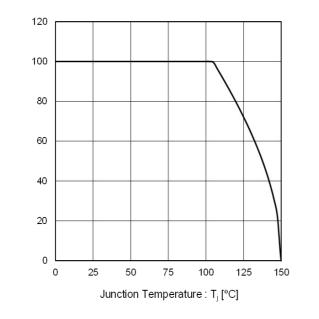
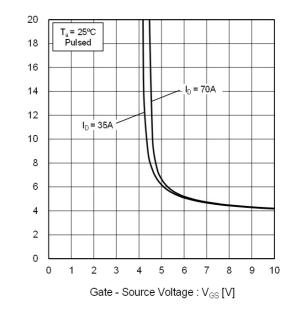


Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage



Static Drain - Source On-State Resistance : $R_{\text{DS}(\text{on})}$ [m\Omega]



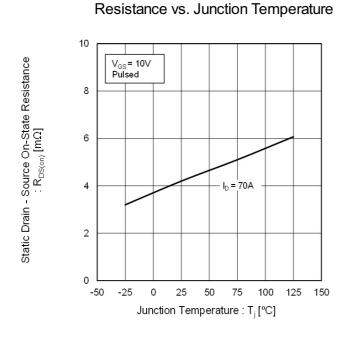


Fig.13 Static Drain - Source On - State

Fig.14 Static Drain - Source On - State Resistance vs. Drain Current (I)

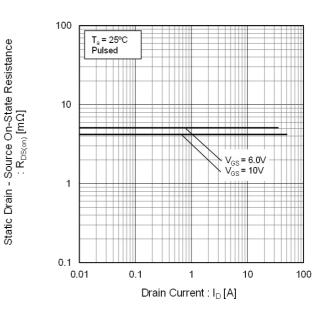


Fig.15 Static Drain - Source On - State Resistance vs. Drain Current (II)

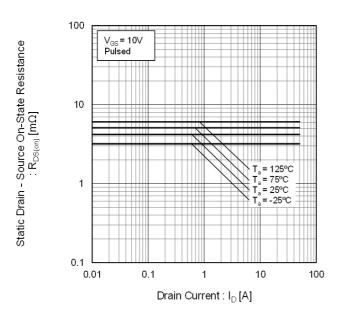
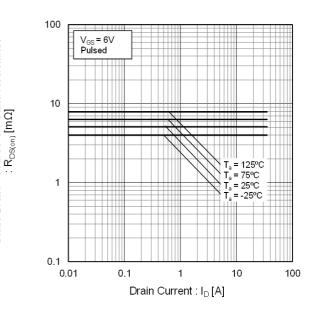


Fig.16 Static Drain - Source On - State Resistance vs. Drain Current (III)



Static Drain - Source On-State Resistance



• Electrical characteristic curves

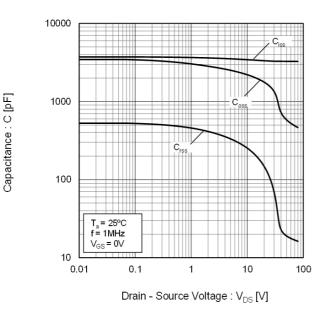
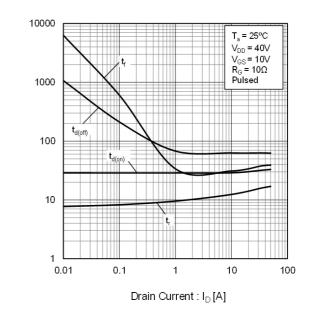


Fig.17 Typical Capacitances vs. Drain - Source Voltage



Switching Time : t [ns]

Fig.18 Switching Characteristics

Fig.19 Typical Gate Charge

Gate - Source Voltage : V_{GS} [V]

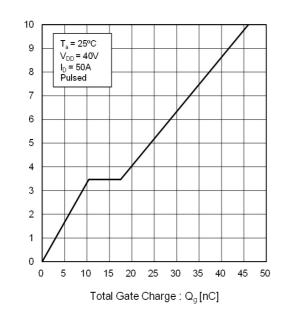
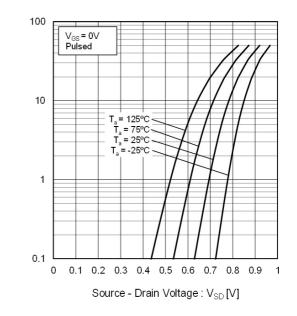


Fig.20 Source Current vs. Source Drain Voltage



Source Current : I_s [A]



Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

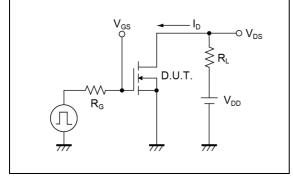


Fig.2-1 Gate Charge Measurement Circuit

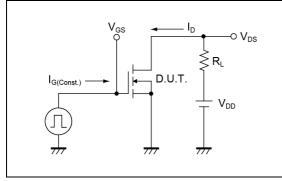


Fig.3-1 Avalanche Measurement Circuit

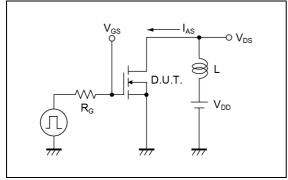


Fig.1-2 Switching Waveforms

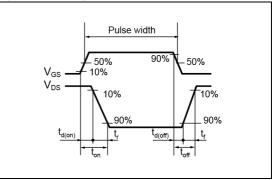


Fig.2-2 Gate Charge Waveform

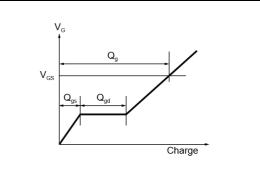
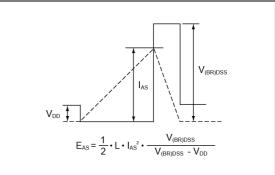
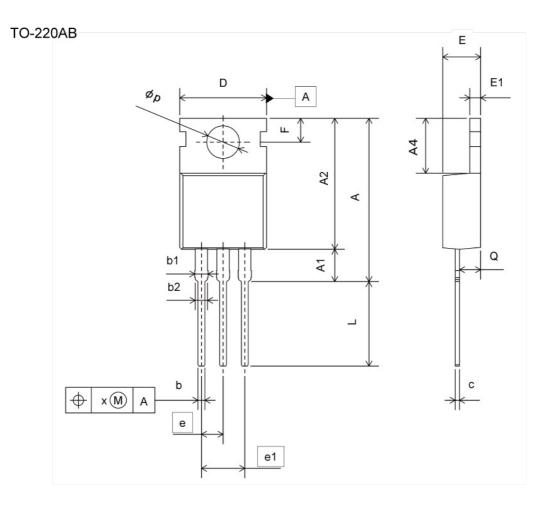


Fig.3-2 Avalanche Waveform





Dimensions



	MILIME	ETERS	INC	HES	
DIM	MIN	MAX	MIN	MAX	
A	18.30	20.00	0.720	0.787	
A1	3.60	4.00	0.142	0.157	
A2	14.70	16.00	0.579	0.630	
A4	6.30	6.60	0.248	0.260	
b	0.65	0.95	0.026	0.037	
b1	1.20	1.75	0.047	0.069	
b2	1.20	1.70	0.047	0.067	
С	0.35	0.65	0.014	0.026	
D	9.96	10.36	0.392	0.408	
E	4.24	4.64	0.167	0.183	
E1	1.14	1.40	0.045	0.055	
е	2.	54	0.1	00	
e1	5.	08	0.200		
F	2.60	3.00	0.102	0.118	
L	9.47	10.37	0.373	0.408	
φp	3.69	3.99	0.145	0.157	
Q	2.30	2.70	0.091	0.106	
х	-	0.38	-	0.015	

Dimension in mm/inches





Notice

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1. Our Products are designed and manufactured for application in ordinary electronic equipment (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (^{Note 1)}, transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSI	CLASS II b	CLASSII
CLASSⅣ	CLASSII	CLASSⅢ	CLASSI

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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